WO 2005/056628 PCT/US2004/030566

CLAIMS

What is claimed is:

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1. A method of forming adjacent layers of materials on a substrate, comprising:

providing a first solution comprising a first material that is a water-soluble cationic conjugated polymer and a first solvent;

providing a second solution comprising a second material and a second solvent;

depositing a first layer of one of said first and second solutions onto a substrate;

depositing a second layer of the other of said first and second solutions onto the first layer;

wherein the material deposited in the first layer does not dissolve in the solvent deposited in the second layer.

- 2. The method of claim 1, wherein the first solvent comprises water.
- 3. The method of claim 1, wherein the first solution comprises a detergent.
- 4. The method of claim 1, wherein depositing the first solution onto the substrate comprises spin-casting.
 - 5. The method of claim 1, wherein the substrate is a film.
- 6. A method of adding a polymer layer to a substrate, comprising:

 providing a first solution of a cationic water-soluble conjugated polymer in a solvent;

providing a substrate comprising a material not soluble in the solvent; depositing the first solution on the substrate.

7. The method of claim 6, wherein the solvent comprises water.

WO 2005/056628 PCT/US2004/030566

8. The method of claim 6, wherein depositing the first solution onto the substrate comprises spin-casting.

- 9. The method of claim 6, wherein the substrate is a film.
- 10. A multilayer electronic device comprising a layer of a water-soluble5 cationic conjugated polymer.
 - 11. The method of claim 1, wherein the substrate is rigid.
 - 12. The method of claim 6, wherein the substrate is rigid.
 - 13. A substrate comprising a polymeric layer produced by the method of claim 1.
- 10 14. An electrical component comprising the substrate of claim 13.
 - 15. The electrical component of claim 14, wherein the component is selected from the group consisting of a laser, a photodiode, a light-emitting diode ("LED"), an optical interconnect, a transducer, a semiconductor chip, a semiconductor thin-film, and a polymeric photoswitch.
- 16. The electrical component of claim 15, wherein the component is a photodiode.
 - 17. The electrical component of claim 15, wherein the component is a light-emitting diode (LED).
 - 18. The electrical component of claim 15, wherein the component is a laser.
- 20 19. The electrical component of claim 15, wherein the component is a transducer.

WO 2005/056628 PCT/US2004/030566

20. The electrical component of claim 15, wherein the component is a polymeric photoswitch.